Intel[®] IXF18104 10 Gigabit LAN PHY

ww.datasheet4u.com

Product Overview

The Intel® IXF18104 is a highly integrated solution for 10GbE Local Area Network (LAN) port applications compliant as per IEEE802.3ae specifications. The IXF18104 supports the 10GbE LAN mode of operation for transport of Ethernet frames in LAN (10.3125Gbps) applications.

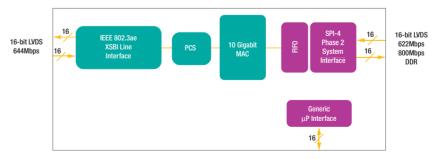
The 10 Gigabit MAC (per IEEE 802.3ae) handles frame encapsulation, verification, 10GbE flow control, and Remote Monitoring/ Simple Network Management Protocol (RMON/ SNMP) statistics management. The IXF18104 also handles the 802.3ae Physical Coding Sub-layer (PCS) functions of the 10 Gigabit Ethernet standard. The PCS hardware handles the 64B/66B encoding/decoding to provide the transition density and balance of the 10.3125Gbps stream.

The system interface supports the industrystandard System Parallel Interface Level 4 (SPI-4) Phase 2. This interface is 16 bits wide with 622Mbps–800Mbps Double Data Rate (DDR) clocking. The SPI-4 Phase 2 interface is Low Voltage Differential Signaling (LVDS), which provides the customer with less connection concerns than previous 64-bit High-Speed Transport Layer (HSTL) interfaces.



On the line side, the IXF18104 supports the LAN version of the IEEE 802.3ae XSBI interface. The 16-bit LVDS interface operates at 644Mbps to support the 10GbE LAN rate of 10.3125Gbps.

The IXF18104 also supports an integrated Pseudo Random Bit Sequence (PRBS) packet generator/analyzer for the PCS. Line remote, line local, system remote, and system local loop backs are supported for general development functionality test and debug.



Intel® IXF18104 Block Diagram

intel

www.DataSheet4U.com

Intel® IXF1810x Family of 10Gbps Physical Layer Devices—High Level Overview

The Intel family of 10 Gigabit framer devices provide the broadest support for 10Gbps solutions. The protocols supported are STS-192c POS, 10 Gigabit Ethernet WAN, 10 Gigabit Ethernet LAN, and GFP framing. The table below summarizes the high-level feature set:

www.datasheet4u.com

Part Number	Feature Set	
IXF18101	 STS-192c/STM 64c POS GFP 10 GbE LAN and WAN with MAC, PCS, and WIS 	SFI-4/XSBI line side interfaceSPI-4 Phase 2 system-side interface
IXF18102	STS-192c/STM 64c POSGFP	SFI-4 line side interfaceSPI-4 Phase 2 system-side interface
IXF18103	 10 Gigabit Ethernet LAN and WAN PHY with MAC, PCS, and WIS 	XSBI line side interfaceSPI-4 Phase 2 system-side Interface
IXF18104	 10 Gigabit Ethernet LAN PHY with MAC, and PCS 	XSBI line side interfaceSPI-4 Phase 2 system-side Interface

All these devices are pin-, footprint-, and register set-compatible. This allows customers to design one line card for multiple applications, providing cost savings over a single line card with other unsupported features.

The IXF18104 is designed to provide a power- and cost-competitive solution for 10GbE LAN Physical Layer and MAC requirements for metro and core networks, and offers the following features and benefits:

Features	Benefits	
 10GbE LAN PHY 	 Device is optimized to support low cost and low power requirements of 10GbE LAN line card applications 	
 XSBI 	 The XSBI interface comprised of 16-bit LVDS I/O runs at 644Mbps for 10GbE LAN applications 	
 SPI-4/Phase 2 	 Helps minimize pin count and allows interface architecture to be scaled beyond 10Gbps LVDS I/O, which improves signal integrity versus HSTL implementation It is independent of the type of data protocol being transferred 	
 Integrated 10GbE MAC, PCS, WIS 	 Highly integrated 10GbE solution vs. discrete MAC and PCS solutions 	
 Multiple types of flow control: Based on internal FIFO watermarks External host control logic 	 Provides flexible loss less flow control which is very important in asynchronous network applications 	

Key Applications

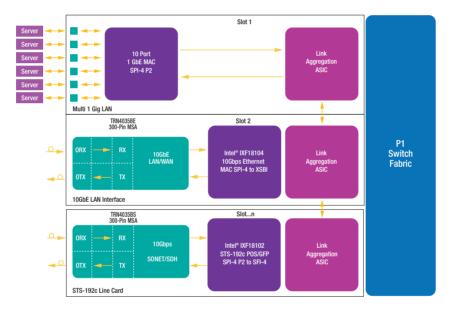
- Terabit Switch/Router Platforms
- Edge and Core Router Platforms
- SONET/SDH Add/Drop Multiplexers

www.datashMulti-Service Provisioning Platforms

- 10GbE PMON in Long-Haul Transport
- Metro POP Ethernet Switches
- Storage Area Networks
- Network Attached Storage
- Emerging Resilient Packet Ring (RPR)
- Dynamic Packet Transport applications

lntel[®] IXF18104 Advantage

- Supports advanced SPI-4 Phase 2 instead of only the basic HSTL interface
- Footprint-compatible with the Intel® IXF18101x device family to provide cost reduction for customers who may only need a subset of the IXF18101 functionality
- Optimized for power- and cost-competitive 10GbE LAN line card applications



Support Collateral/Tools

Item	Description	Order Number
IXF18104	10 Gigabit LAN PHY Technical Product Brief	249941
IXF18104	10 Gigabit LAN PHY Short Form Specifications Preview	273607

The following document is available only subject to NDA

IXF18104 Data Sheet

Contact your local rep

www.datasheet4u.com

Intel Advantage

Intel is a leading supplier of communications building blocks, adding value at many levels of integration. Through continuous innovations and advancements in Ethernet connectivity and processing in the network, Intel is delivering, along with its customers and developer community, a wide choice of solutions that enable faster time-to-market, longer time-in-market and increased revenue opportunity.

Intel Access

Developer Web Site	http://developer.intel.com	
Networking Components Home Page	http://developer.intel.com/design/network	
Intel Literature Center	http://developer.intel.com/design/litcentr (800) 548-4725 7 a.m. to 7 p.m. CST (U.S. and Canada) International locations please contact your local sales office.	

General Information Hotline

(800) 628-8686 or (916) 356-3104 5 a.m. to 5 p.m. PST

Information in this document is provided in connection with Intel products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is Intermation in this document is provided in connection with multiproducts, to incertise, express or implied, by escopper or outerwise, to any intellectual property nairs any spranted by this document. Except as provided in Intel[®] Ferms and Conditions of Sale for such products, intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right. Intel products are not intended for use in medical, life-saving or life-sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined." Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them.



Intel is a trademark or registered trademark of Intel Corporation or its subsidiaries in the United States and other countries *Other names and brands may be claimed as the property of others.

For more information, visit the Intel Web site at: developer.intel.com

UNITED STATES AND CANADA Intel Corporation Robert Noyce Building 2200 Mission College Blvd. P.O. Box 58119 Santa Clara, CA 95052-8119 USA

EUROPE Intel Corporation (UK) Ltd. Pipers Way Swindon Wiltshire SN3 1RJ

ASIA-PACIFIC Intel Semiconductor Ltd. 32/F Two Pacific Place 88 Queensway, Central Hong Kong, SAR

JAPAN Intel Japan (Tsukuba HQ) 5-6 Tokodai Tsukuba-shi

SOUTH AMERICA Intel Semicondutores do Brasil LTDA Av. Dr. Chucri Zaidan, 940-10° andar 04583 -904 São Paulo, SI anan Www.DataSheet4U.com